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EFFECTIVE DATE: 2015-10-26

SPECIFICATION OF LCD MODULE

MODULE NO: CTP035B0

Customer Approval:		
☐ Accept		☐ Reject
FUTURE FOCUS	SIGNATURE	DATE
PREPARED BY		
CHECKED BY		
APPROVED BY		



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- I.CTP产品通用检验标准 General Inspection Specification for CTP (Class A1)
- II.工程图 Counter Drawing
- III.包装图纸 Packaging Drawing



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1.概述 General

项目	描述	备注
Item	Description	Remark
产品型号	CTP035B0	
Part No	CTF033B0	
视窗尺寸	2.5 inch diagonal	
Viewing Area	3.5 inch diagonal	
产品结构	G+G	
Product Structure	GTG	
品质标准	1	详见附页 I
Inspection Specification		Refer to Appendix I

2.产品用途	Application
--------	--------------------

[] 消费电子 Consumer Electronics	[√] 非消费类 Non-Consumer
[] 工业类 Industrial	[] 车载 Automotive
[] 其他用途 Others:	_

3.产品特性 Characteristics

3.1 结构特性 Structure Characteristics

项目	规格	材料	备注
Item	Specification	Material	Remark
盖板	详见附页II	玻璃	
Cover Lens	Refer to Appendix II	Glass	
表面处理	1	,	
Surface Treatment	/	1	
TP 粘结层	1	光学透明胶	
TP Adhesive Layer	1	OCA	
功能片	详见附页II	ITO玻璃	
Sensor	Refer to Appendix II	ITO Glass	
驱动芯片	FT5416	,	
Driver IC	F15410	1	
模组粘结层	,		
Module Adhesive Layer	1		
显示模组	详见附页Ⅱ		
Display Module	Refer to Appendix II	'	
产品净重	240	1	仅供参考
Product Net Weight	24g	<i>'</i>	Reference only

Cover Lens]		
TP Adhesive Layer	IC		
Sensor	FPC		
触摸屏层叠示意图 Touch Panel Structure I			



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3.2 温度和光学特性 Temperature and Optical Characteristics

项目	描述	备注
Item	Description	Remark
工作温度	-20 °C ~ 70°C	
Operating Temperature	-20 0 70 0	
储存温度	-30 °C ~ 80°C	
Storage Temperature	-30 C 7 80 C	
触摸屏透过率	≥86%	550nm波长
TP Transmittance	280 %	@550nm wavelength
		550nm波长
感光孔透过率	/	@550nm wavelength
IR Hole Transmittance	,	850nm波长
	/	@850nm wavelength

3.3 机械特性 Mechanical Characteristics

项目	描述	备注
Item	Description	Remark
表面硬度	6H	铅笔测试,负载500g,45度
Surface Hardness	ОП	Pencil, Loading 500g, 45 deg
落球	40cm	钢球重量64g
Ball-falling Test	400111	Steel ball weight 64g
FPC弯折测试	10times	弯折半径大于1mm
FPC bending test	Tournes	R≥1 mm

3.4 电气参数 Electrical Characteristics

[] COB

项目	描述	备注
Item	Description	Remark
通道数		
Channels		

[√] COF

项目	描述	备注
Item	Description	Remark
操作系统	1	
Operating System	/	
产品ID		
Product ID	1	
支持触点数量	5点	
Touch Count	5点	
支持LCM分辨率	320*240	
Display Resolution Supported	320 240	
TP坐标原点位置	默认	
Origin of Coordinates		
接口形式	IIC	
Interface	IIC .	



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I ² C设置地址 I ² C Slave Address	默认		
供电电压 Power Voltage	3.3V		
接口信号电压 Interface Signal Voltage	1.8V		
电源纹波 Power Ripple	Vpp≤50mV		
工作电流(正常模式)	额定值 Typical Value	1	
Operating Current (Normal Mode)	最大值 Maximum Value	1	
工作电流(休眠模式)	额定值 Typical Value	1	
Operating Current (Sleep mode)	最大值 Maximum Value	1	
说明 Note	详细应用参考对应的IC规格书; Refer to IC specification for details;		

可靠性 Reliability

项目 Item	描述 Description		备注 Remark
高温储存 High Temperature Storage	80 °C X 120Hrs, 5pcs		Hemark
低温储存 Low Temperature Storage	-30℃ X 120Hrs,5pcs	取出后在室温条 件下存放 24 小时	
高温高湿模拟工作 High Temperature- Humidity Simulation of Operating Model	60℃ X 90%RH X 120H	后,无功能不良 No functional defects at room temperature after	
冷热冲击储存 Thermal Shock Cycle - Storage	(-30 °C X30mins → 25 °C X X30mins → 25 °C X10min 5pcs	24 hours	
ESD 测试	空气放电 Air Discharge	±8KV, 5pcs	整机测试
ESD Test	接触放电 Contact Discharge	±4KV, 5pcs	Terminal Testing
包装震动 Vibration Test for Packaging	频率4.2Hz,振幅1英寸 数量1箱 Frequency 4.2Hz, Swin carton.	试验后外观无损 伤功能无异常 No visual	
包装跌落 Drop Test for Packaging	一角三棱六面,高度0.8 Drops on one corner, the sides; Drop height: 0.8	rree edges, and six	damages and functional defects



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5.保存期限 Shelf Life

考虑到 TP 长时间存放有保护膜残胶的风险,我们建议客户收到货后 1 个月内完成组装。

It is recommended that TP assembly must be completed within one month upon receipt, considering the risk that the protective film glue may stick to the surface of TP when stored for more than one month.

6.保修期限 Warranty

自出货之日起 1 年内发现的不良(按本规格书规定的储存和使用条件下),OD 可以安排修理或换货。 OD warrants that the products wil be free from defects for a period of twelve (12) months from the date of shipment when used under the specified storage and utilization conditions of this specification. Defective products of OD Display's making, once proved, will be either repaired or replaced.

7.操作注意事项 Handling Precaution

- 7.1 由于电容式触摸屏是由玻璃所制,请勿强力撞击,或高处落下。Do not apply strong stress on CTP product, or drop it from heights as it is made of glass.
- 7.2 为确保产品洁净度,请在接触产品之前戴上清洁的指套、手套和面罩以免留下指纹。Must wear glove or finger cots at handling to avoid fingerprint on screen.
- 7.3 制品上有污沾时, 请以柔质绵布或沾有中性洗剂/酒精的布料轻拭。To remove dirt or contamination on the surface, use soft cotton or cloth with ethanol / alcohol wipe off gently.
- 7.4 拿取产品时请勿拉其尾端(FPC)提起产品,请提起产品本体。Holding the panel body instead of FPC at all time.
- 7.5 安装时请勿过度折弯或强力拉扯 FPC,避免造成折伤。Do not over-bend or pull the FPC when installing or handling, to avoid FPC damage.
- 7.6 安装时请勿用硬物接触电容式触摸屏背后的油墨,避免造成刮伤。Do not contact the ink behind CTP with hard object to avoid scratches when

installing or handling.

- 7.7 请勿以锐利刀刃或其它尖锐物在产品上划动磨擦。Do not scratch or rub with knives or other sharp object.
- 7.8 请勿任意拉扯、弯折、剥离或拆解产品。Do not stretch、bend、detach or disassemble product.
- 7.9 请勿将产品堆叠放置以免引起表面刮花造成外观不良。In order o avoid scratch, do not pile products.
- 7.10 请避免将产品靠近或暴露于有机溶剂, 酸性气体的环境下使用及存放。Keep away from organic solvent or acidic environment.
- 7.11 产品使用需要避免高压和静电。Pay Attention to high voltage and static electricity.
- 7.12 操作电容式触摸屏时,请采用手指或导电性笔触摸。Please touch with finger or electric pen during operating CTP.



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Management System of Third-order Document

CTP inspection specification for customer

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Pages	9	Customer approval	
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Revision Record							
Section	Revision Summary	Rev.	Effective Date				
1-7	The whole file was adjusted to use quality center new file No.	V2.0	2015-7-3				
5. 4	Modify inspection luminance	V2. 1	2015-11-19				
6. 2. 6	Modify definition of stain defect on the surface of finished product	V2. 1	2015-11-19				



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1. Purpose

The purpose of this specification is to establish CTP appearance and function inspection standard for defining inspection items, methods and standard to ensure meeting customer requirements.

2. Scope

This specification is applicable to capacitive touch panel manufactured by OD.

3. Equipment for inspection

lamp-box, ionizing fan , 10X microscopes , film card, alcohol/oil ether/acetone, finger cots, vernier caliper, anti-static wrist straps, microcalliper, feeler, pencil hardness tester, spectrophotometer , drop ball test,etc.

4. Sampling Plan and Reference Standards

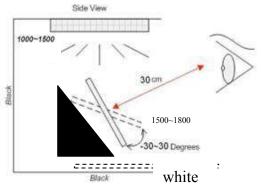
Appearance inspection and function test are based on GB/T 2828.1---2012/ISO2859-1:1999. Normally checking the sampling plan one time and performing general inspection level II.

Product	consumer electronics	Non-consumer electronics	Industrial control	vehicle	
AQL	MA=0.4 MI=1.5	MA=0.4 MI=1.0	MA=0.25 MI=0.65	MA=0.15 MI=0.4	

5. Inspection Conditions and Inspection Reference

- 5.1 Inspection environment: temperature: 23±3°C; humidity: 45~75%RH; cleanness: 10000 grade;
- 5.2 Inspection distance: 30cm±5cm;
- 5.3 Inspection angle: vertical rotate angle: ±30°, up->down;horizontal rotate angle:±30°,left->right
- 5.4 Inspection luminance: fluorescent (finished product) inspection luminance is 800~1000Lux;
- 5.5 Background color: black/white;
- 5.6 Inspection time : 10~15s/pcs;

Black Booth or Black Background



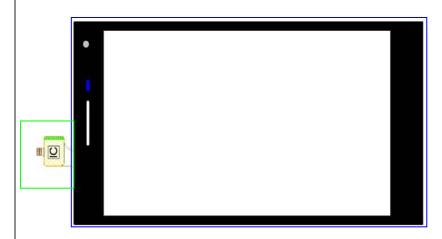
- 5.7 Area partition:
- 5.7.1 A area: front side visible area BM(Black Mask), the area encircled by blue lines.
- 5.7.2 B area: four broadside(inspect from broadside) area & FPC area, encircled by green lines.



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5.8 Defect type:

5.8.1 A area defect type:

line defect (scratch, soft flocks, fibre), dot defect (white dot, black dot, same color dot, different color dot, dust, bubble), surface stain, pinhole, light leak, scratch.

5.8.2 B area defect type:

broken, crack/chipping, FPC defect

5.9 Beyond above items, judge by the limited sample.

6. Defects and Acceptance Standards

6.1 Electrical properties test

Check with OD tester. The program will release result automatically. There are "OK", "PASS", "NG" and the final judgment must be "OK" "PASS", and we need to pass the draw line test.

Refer to 《**serise IC test program》

No.	Defect	Description	Accepted standard	MA J	MI N
6.1.1	short	Measured data has much difference compared with normal; line is not stable	Reject	~	
6.1.2	open	Measured data has no change.line is open	Reject	\checkmark	
6.1.3	No reaction	No reaction and there is no line in screen	Reject	\checkmark	
6.1.4	Mis-dispaly/ abnormaly display	Screen has display but line is open or bent	Reject	√	
6.1.5	Botton no reaction	Press the botton but no reaction	Reject	\checkmark	
6.1.6	Botton no correct	Press the botton .reaction is not stable	Reject	\checkmark	

6.2 Appearance inspection

6.2.1 dot/line defect



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Defect	≦ 6"	6~11"	11~15"	>15"	Accepted standard	MAJ	MIN
S/C , line defect	Tactile S/C->NG	Tactile S/C->NG	Tactile S/C->NG	Tactile S/C->NG	Reject		\checkmark
	W≤0.03mm,	W≤0.05mm,	W≤0.05mm,	W≤0.05mm,			
W:width	->OK;	->OK;	->OK;	->OK;	Accept		$\sqrt{}$
1	Density is high	Density is high	Density is high	Density is high	Песері		,
	->NG	->NG	->NG	->NG			
L 1"	0.03mm $<$	0.05mm $<$	0.05mm<	0.05mm<			
19	W≤0.10mm,	W≤0.1mm,	W≤0.1mm,	W≤0.1mm,			
	L≤5mm	L≤8mm	L≤10mm	L≤12mm	Accept		
	quantity≤2	quantity≤3	quantity≤2	quantity≤2	Постр		,
	distance>	distance>	distance>	distance>			
	10mm	10mm	10mm	10mm			
	W>0.10mm	W>0.1mm	W>0.1mm	W>0.1mm	Reject		
	L>5mm	L>8mm	L>10mm	L>12mm	regeet		,
Dot defect	W≤0.10mm,	W≤0.15mm,	W≤0.15mm,	W≤0.15mm,			
D:Diameter	->OK;	->OK;	->OK;	->OK;	Accept		V
→ı ^x ı— ↓	Density is high ->NG	Density is high ->NG	Density is high ->NG	Density is high ->NG			•
• <u>+</u> Y	0.10mm <d<< th=""><th>0.15mm<d≤< th=""><th>0.15mm<d≤< th=""><th>0.20mm<d<< th=""><th></th><th></th><th></th></d<<></th></d≤<></th></d≤<></th></d<<>	0.15mm <d≤< th=""><th>0.15mm<d≤< th=""><th>0.20mm<d<< th=""><th></th><th></th><th></th></d<<></th></d≤<></th></d≤<>	0.15mm <d≤< th=""><th>0.20mm<d<< th=""><th></th><th></th><th></th></d<<></th></d≤<>	0.20mm <d<< th=""><th></th><th></th><th></th></d<<>			
D= (x + y) / 2	0.10mm < D_	0.13mm \D_\(\sigma\)	0.13Hill \(\mathbb{D}\)\(\sigma\)	0.20mm \ 0.50mm			
	quantity≤2	quantity≤3	quantity≤3	quantity≤3	Accept		$\sqrt{}$
(A)	distance>	distance>	distance>	distance>	riccopt		,
	10mm	10mm	10mm	10mm			
	D>0.25mm	D>0.30mm	D>0.40mm	D>0.50mm	Reject		$\sqrt{}$

6.2.2 LENS defect

Defect	Description	Accepted standard	MAJ	MIN
Printing zigzag	zigzag width which is almost the same with VA area W≤0.15mm	Accept		√
	zigzag width which is almost the same with VA area $W>0.15 mm$	Reject		\checkmark
Wire mark	≤0.15mm	Accept		√
	>0.15mm	Reject		√



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Ink pinhole	Invisible with reflector light	Accept		√
Ink film defect	Ink film:s/c, soft flocks, fibre Ink film stain/color shift:refer to limited sample Ink film foreign material/scratch: refer to 6.2.1 visible area judgment	Accept		√
Ink light leak	Broadside light leak width≤0.15mm Each side light leak quantity≤1			V
Ink color shift	Refer to limited sample			\checkmark
font、glass silver line(ink area)	D≤0.20mm; N≤2 ↑	Accept		V
width≥0.2mm	D>0.20mm	Reject		√
PaiTab sunset	Refer to limited sample, if it's out of spec	Reject		V
word/color error	Word or color or position is different from drawing and sample.	Reject	√	
word missing (width≤0.2mm)	height, a≤1/4h, width≤1/2w	Accept		V
Font thickness different and color nonuniform	Refer to limited sample, if it's out of spec	Reject		V
IR/video/receive	Irregular hole, offside, refer to drawing	Accept		$\sqrt{}$
hole/ Button hole	Foreign material/scratch exist in hole,refer to 6.2.1	Reject		V



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LENS broadside foreign material	Width≤ 0.15mm	Accept	√
Ink spill	LENS broadside or receive hole or button hole have ink spill defect, refer to limited sample.	Accept	V

6.2.3 Breakage

		1				T	
Defect	≦ 6"	6~11"	11~15"	>15"	Accepted standard	MAJ	MIN
LENS breakage	$X \le 0.3 \text{mm}$, $Y \le 0.3 \text{mm}$, one side ≤ 1	X≤0.3mm, Y≤0.4mm, one side≤1	X≤0.4mm, Y≤0.4mm, one side≤1	X≤0.5mm, Y≤0.5mm, one side≤1	Accept		\checkmark
	X>0.3mm, Y>0.3mm	X>0.3mm, Y>0.4mm	X>0.4mm, Y>0.4mm	X>0.5mm, Y>0.5mm	Reject		$\sqrt{}$
Sensor breakage			engthen,function te after attaching Le		Accept		\checkmark
something of the same of the s		affect ITO lin	e and be visual		Reject		$\sqrt{}$
Glass crack		Crack length	nen to outside		Accept		V
		Crack lengt	hen to inside		Reject		V

6.2.4 FPC defect

Defect	Description	Accepted standard	MAJ	MIN
FPC folding	FPC is folding and can not restore-> Reject FPC is folding and can restore->compare with limited sample	Reject		√
FPC cover layer defect	FPC cover layer peeling off	Reject		√
FPC color shift and bubble	PI layer have color shift or bubbled due to high welding temperature or long welding time.	Reject		V
Golden finger defect	peeling off bonding deformed glue remained oxidized, stained	Reject		V



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Joggle defect	bent, broken, peeling off	Reject	√
FPC defect	(golden finger) dented, pin hole a≤w/3	Accept	\checkmark
	open/scratch/cracked	Reject	√
	oxidized, stained	Reject	\checkmark
FPC loophole	Soft loophole≤2.0mm, hard (PCB、PC、steel cover layer) loophole≤1.0mm	Accept	V

6.2.5 Attaching defect (protective film/adhesive tape/foam/PC...)

Defect	Description	Accepted standard	MAJ	MIN
High temperature glue paper	1.Glue paper attached in FPC doesn't cover component or FPC cove layer.2.Glue paper attached in golden finger doesn't cover golden finger or peel off	Reject		V
	Clean, attaching flat, no shifting or bubble	Accept		\checkmark
Protective film	Protective film attaching bubble in VA: D≤2.0mm N≤5 distance≤20mm	Accept		\checkmark
	Protective film attaching bubble in VA: D>2.0mm N>5 distance>20mm	Reject		\checkmark
Tape	Attach position refer to the drawing	Accept		$\sqrt{}$
Foam	Gap spec:0.5+/-0.5mm, foam must be smaller than sensor edge side and can not enter into VA.	Accept		√
PC board/ adhesive tape	Tape must be smaller than LENS edge side and can not be folding ,dent or shifting.	Accept		V
Anti-explosion fim/Anti-glare	Impression print refer to the limited sample	Accept		$\sqrt{}$
film/blue film	Attach position refer to the drawing	Accept		V

6.2.6 Others



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